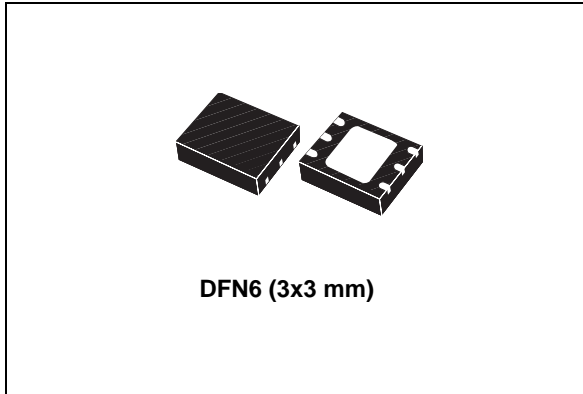


1 A, low quiescent current, low-noise voltage regulator

Datasheet - production data



Description

The LD39100 provides 1 A maximum current with an input voltage range from 1.5 V to 5.5 V and a typical dropout voltage of 200 mV. The device is stable with ceramic capacitors on the input and output. The ultra low drop voltage, low quiescent current and low-noise features make it suitable for low power battery-powered applications. Power supply rejection is 70 dB at low frequency and starts to roll off at 10 kHz. Enable logic control function puts the LD39100 in shutdown mode, allowing a total current consumption lower than 1 μ A. The device also includes short-circuit constant current limiting and thermal protection.

Features

- Input voltage from 1.5 to 5.5 V
- Ultra low-dropout voltage (200 mV typ. at 1 A load)
- Very low quiescent current (20 μ A typ. at no load, 200 μ A typ. at 1 A load, 1 μ A max. in off mode)
- Very low-noise with no bypass capacitor (30 μ V_{RMS} at V_{OUT} = 0.8 V)
- Output voltage tolerance: \pm 2.0% @ 25 °C
- 1 A guaranteed output current
- Wide range of output voltages available on request: 0.8 V to 4.5 V with 100 mV step and adjustable from 0.8 V
- Logic-controlled electronic shutdown
- Stable with ceramic capacitors C_{OUT} = 1 μ F
- Internal current and thermal limit
- DFN6 (3x3 mm) package
- Temperature range: - 40 °C to 125 °C

Table 1. Device summary

Order codes	Output voltages
LD39100PUR	Adj. from 0.8 V
LD39100PU12R	1.2 V
LD39100PU25R	2.5 V
LD39100PU30R	3.0 V

Applications

- Printers
- Personal digital assistants (PDAs)
- Cordless phones
- Consumer applications

Contents

1	Circuit schematics	3
2	Pin configuration	4
3	Maximum ratings	5
4	Electrical characteristics	6
5	Typical performance characteristics	9
6	Application information	14
	6.1 Power dissipation	15
	6.2 Enable function	16
	6.3 Power Good function	16
7	Package mechanical data	17
8	Packaging mechanical data	20
9	Revision history	22

1 Circuit schematics

Figure 1. LD39100 schematic diagram (adjustable version)

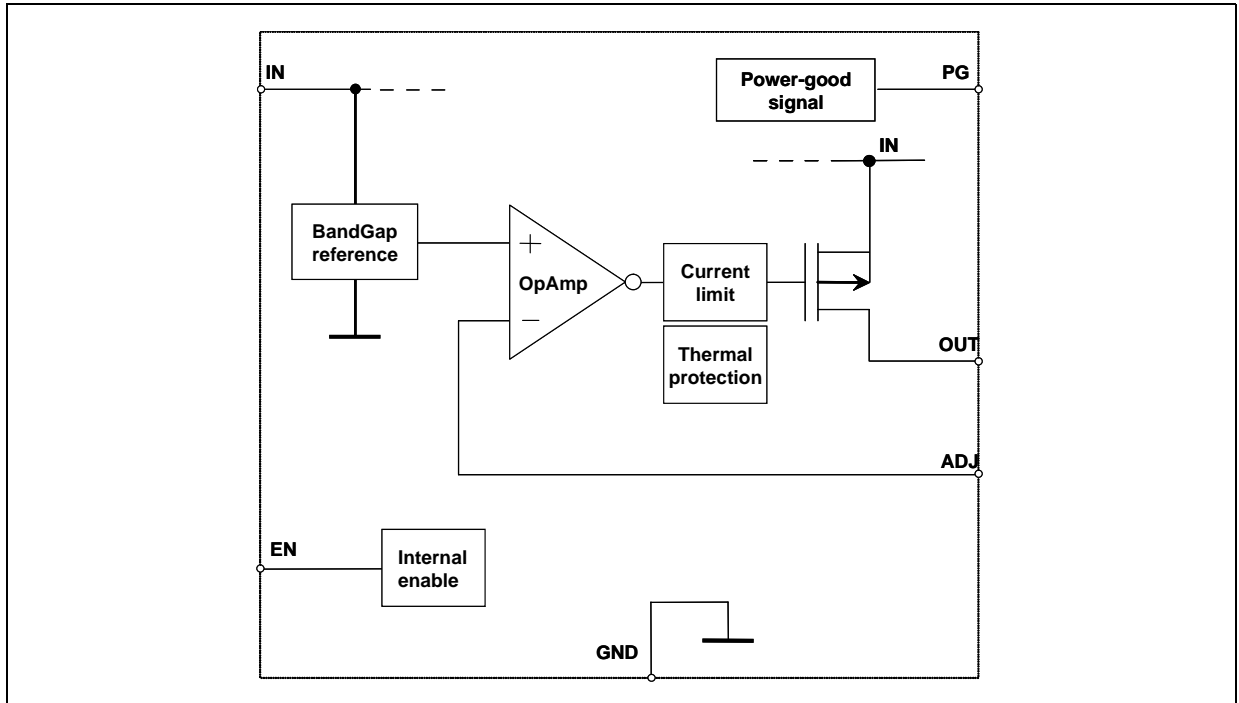
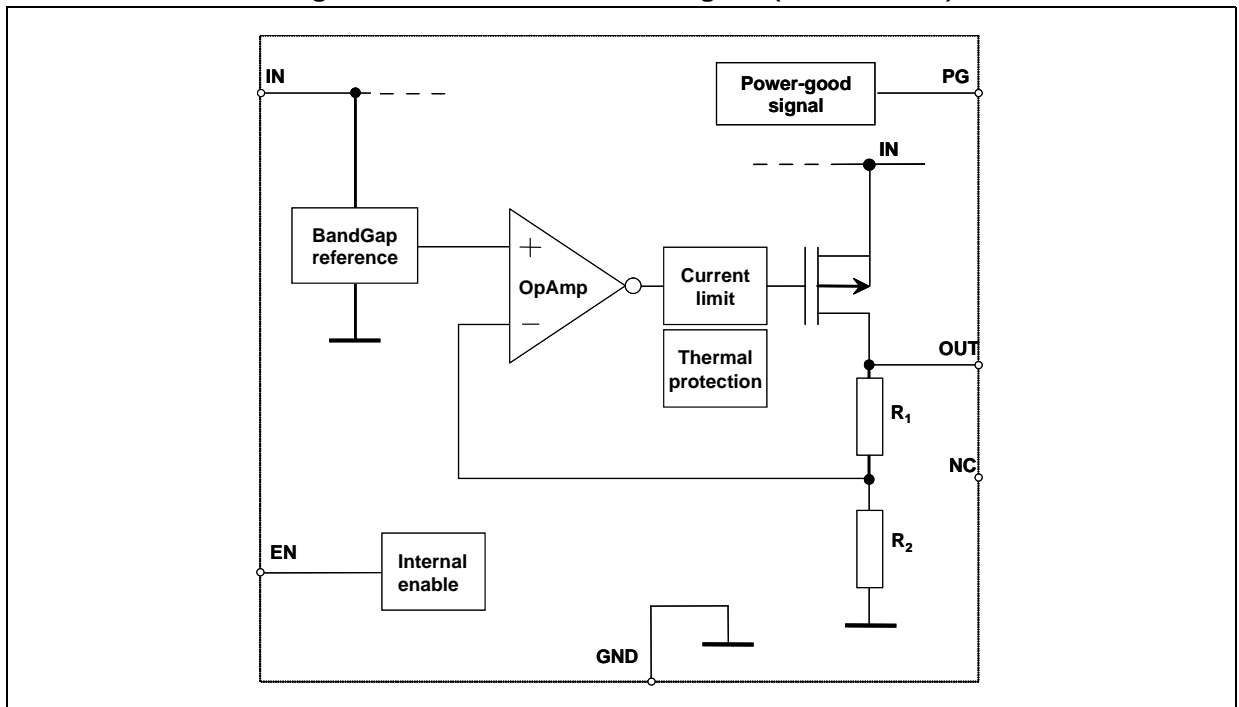


Figure 2. LD39100 schematic diagram (fixed version)



2 Pin configuration

Figure 3. Pin connection (top view)

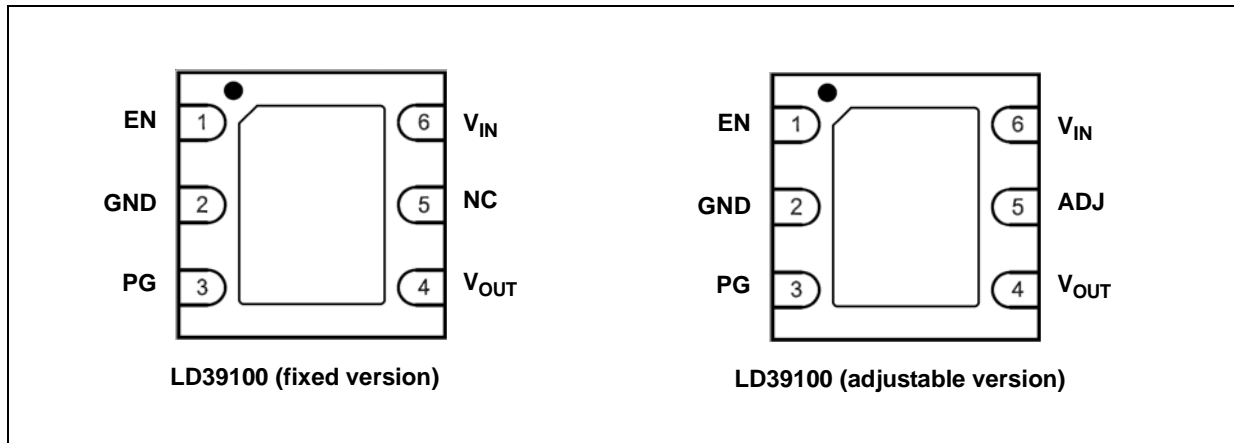


Table 2. Pin description

Symbol	Pin		Function
	LD39100 (adjustable version)	LD39100 (fixed version)	
EN	1	1	Enable pin logic input: low = shutdown, high = active
GND	2	2	Common ground
PG	3	3	Power Good
V _{OUT}	4	4	Output voltage
ADJ	5	-	Adjust pin
V _{IN}	6	6	LDO input voltage
NC	-	5	Not connected
GND	Exposed pad		Exposed pad has to be connected to GND

3 Maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{IN}	DC input voltage	-0.3 to 7	V
V_{OUT}	DC output voltage	-0.3 to $V_{IN} + 0.3$ (7 V max.)	V
EN	Enable pin	-0.3 to $V_{IN} + 0.3$ (7 V max.)	V
PG	Power Good pin	-0.3 to 7	V
ADJ	Adjust pin	4	V
I_{OUT}	Output current	Internally limited	
P_D	Power dissipation	Internally limited	
T_{STG}	Storage temperature range	- 65 to 150	°C
T_{OP}	Operating junction temperature range	- 40 to 125	°C

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. All values are referred to GND.

Table 4. Thermal data

Symbol	Parameter	Value	Unit
R_{thJA}	Thermal resistance junction-ambient	55	°C/W
R_{thJC}	Thermal resistance junction-case	10	°C/W

Table 5. ESD performance

Symbol	Parameter	Test conditions	Value	Unit
ESD	ESD protection voltage	HBM	4	kV
		MM	0.4	kV

4 Electrical characteristics

$T_J = 25\text{ }^\circ\text{C}$, $V_{IN} = 1.8\text{ V}$, $C_{IN} = C_{OUT} = 1\text{ }\mu\text{F}$, $I_{OUT} = 100\text{ mA}$, $V_{EN} = V_{IN}$, unless otherwise specified.

Table 6. LD39100 electrical characteristics (adjustable version)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{IN}	Operating input voltage		1.5		5.5	V
V_{ADJ}	V_{ADJ} accuracy	$I_{OUT}=10\text{mA}$, $T_J = 25^\circ\text{C}$	784	800	816	mV
		$I_{OUT}=10\text{mA}$, $-40^\circ\text{C}<T_J<125^\circ\text{C}$	776	800	824	
I_{ADJ}	Adjust pin current				1	μA
ΔV_{OUT}	Static line regulation	$V_{OUT}+1\text{ V} \leq V_{IN} \leq 5.5\text{ V}$, $I_{OUT}=100\text{mA}$		0.01		%/V
ΔV_{OUT}	Transient line regulation ⁽¹⁾	$\Delta V_{IN}=500\text{mV}$, $I_{OUT}=100\text{mA}$, $t_R=5\mu\text{s}$		10		mVpp
		$\Delta V_{IN}=500\text{mV}$, $I_{OUT}=100\text{mA}$, $t_F=5\mu\text{s}$		10		
ΔV_{OUT}	Static load regulation	$I_{OUT}=10\text{mA}$ to 1A		0.002		%/mA
ΔV_{OUT}	Transient load regulation ⁽¹⁾	$I_{OUT}=10\text{mA}$ to 1A, $t_R=5\mu\text{s}$		40		mVpp
		$I_{OUT}=1\text{A}$ to 10mA, $t_F=5\mu\text{s}$		40		
V_{DROP}	Dropout voltage ⁽²⁾	$I_{OUT}=1\text{A}$, V_O fixed to 1.5V $-40^\circ\text{C}<T_J<125^\circ\text{C}$		200	400	mV
e_N	Output noise voltage	10Hz to 100kHz, $I_{OUT}=100\text{mA}$, $V_{OUT}=0.8\text{V}$		30		μV_{RMS}
SVR	Supply voltage rejection $V_O = 0.8\text{ V}$	$V_{IN}=1.8\text{V}+/-V_{RIPPLE}$ $V_{RIPPLE}=0.25\text{V}$, frequency= 1kHz $I_{OUT}=10\text{mA}$		70		dB
		$V_{IN}=1.8\text{V}+/-V_{RIPPLE}$ $V_{RIPPLE}=0.25\text{V}$, frequency=10kHz $I_{OUT}=100\text{mA}$		65		
I_Q	Quiescent current	$I_{OUT}=0\text{mA}$		20		μA
		$I_{OUT}=0\text{mA}$, $-40^\circ\text{C}<T_J<125^\circ\text{C}$			50	
		$I_{OUT}=0$ to 1A		200		
		$I_{OUT}=0$ to 1A, $-40^\circ\text{C}<T_J<125^\circ\text{C}$			300	
		V_{IN} input current in off mode: $V_{EN}=\text{GND}^{(3)}$		0.001	1	
PG	Power good output threshold	Rising edge		0.92*		V
		Falling edge		0.8*		
	Power good output voltage low	$I_{sink}=6\text{mA}$ open drain output			0.4	V
I_{SC}	Short-circuit current	$R_L=0$		1.5		A

Table 6. LD39100 electrical characteristics (adjustable version) (continued)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{EN}	Enable input logic low	$V_{IN}=1.5V$ to $5.5V$, $-40^{\circ}C < T_J < 125^{\circ}C$			0.4	V
	Enable input logic high		0.9			V
I_{EN}	Enable pin input current	$V_{EN} = V_{IN}$		0.1	100	nA
t_{ON}	Turn-on time ⁽⁴⁾			30		μs
T_{SHDN}	Thermal shutdown			160		$^{\circ}C$
	Hysteresis			20		
C_{OUT}	Output capacitor	Capacitance (see typical performance characteristics for stability)	1		22	μF

1. All transient values are guaranteed by design, not tested in production.
2. Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value. This specification does not apply to output voltages below 1.5 V.
3. PG pin floating.
4. Turn-on time is time measured between the enable input just exceeding V_{EN} high value and the output voltage just reaching 95% of its nominal value.

$T_J = 25^{\circ}C$, $V_{IN} = V_{OUT(NOM)} + 1 V$, $C_{IN} = C_{OUT} = 1 \mu F$, $I_{OUT} = 100 mA$, $V_{EN} = V_{IN}$, unless otherwise specified.

Table 7. LD39100 electrical characteristics (fixed version)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_I	Operating input voltage		1.5		5.5	V
V_{OUT}	V_{OUT} accuracy	$V_{OUT} > 1.5V$, $I_{OUT} = 10mA$, $T_J = 25^{\circ}C$	-2.0		2.0	%
		$V_{OUT} > 1.5V$, $I_{OUT} = 10mA$, $-40^{\circ}C < T_J < 125^{\circ}C$	-3.0		3.0	
		$V_{OUT} \leq 1.5V$, $I_{OUT} = 10mA$		± 20		mV
		$V_{OUT} \leq 1.5V$, $I_{OUT} = 10mA$, $-40^{\circ}C < T_J < 125^{\circ}C$		± 30		
ΔV_{OUT}	Static line regulation	$V_{OUT} + 1V \leq V_{IN} \leq 5.5V$, $I_{OUT} = 100mA$		0.01		%/V
ΔV_{OUT}	Transient line regulation ⁽¹⁾	$\Delta V_{IN} = 500mV$, $I_{OUT} = 100mA$, $t_R = 5\mu s$		10		mVpp
		$\Delta V_{IN} = 500 mV$, $I_{OUT} = 100mA$, $t_F = 5\mu s$		10		
ΔV_{OUT}	Static load regulation	$I_{OUT} = 10 mA$ to $1A$		0.002		%/mA
ΔV_{OUT}	Transient load regulation ⁽¹⁾	$I_{OUT} = 10 mA$ to $1A$, $t_R = 5\mu s$		40		mVpp
		$I_{OUT} = 1A$ to $10mA$, $t_F = 5\mu s$		40		
V_{DROP}	Dropout voltage ⁽²⁾	$I_{OUT} = 1A$, $V_{OUT} > 1.5V$, $-40^{\circ}C < T_J < 125^{\circ}C$		200	400	mV
e_N	Output noise voltage	10Hz to 100kHz, $I_{OUT} = 100mA$, $V_{OUT} = 2.5V$		85		μV_{RMS}

Table 7. LD39100 electrical characteristics (fixed version) (continued)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
SVR	Supply voltage rejection $V_{OUT}=1.5V$	$V_{IN}=V_{OUT(NOM)}+0.5V+/-V_{RIPPLE}$ $V_{RIPPLE}=0.1V$, frequency=1kHz $I_{OUT}=10mA$		65		dB
		$V_{IN}=V_{OUT(NOM)}+0.5V+/-V_{RIPPLE}$ $V_{RIPPLE}=0.1V$, frequency=10 kHz $I_{OUT}=100mA$		62		
I_Q	Quiescent current	$I_{OUT} = 0 \text{ mA}$		20		μA
		$I_{OUT} = 0 \text{ mA}$, $-40^\circ C < T_J < 125^\circ C$			50	
		$I_{OUT} = 0 \text{ to } 1A$		200		
		$I_{OUT} = 0 \text{ to } 1A$ $-40^\circ C < T_J < 125^\circ C$			300	
		V_{IN} input current in OFF mode: $V_{EN} = GND^{(3)}$		0.001	1	
PG	Power good output threshold	Rising edge		0.92* V_{OUT}		V
		Falling edge		0.8* V_{OUT}		
	Power good output voltage low	$I_{sINK}=6mA$ open drain output			0.4	V
I_{SC}	Short-circuit current	$R_L=0$		1.5		A
V_{EN}	Enable input logic low	$V_{IN}=1.5 \text{ V to } 5.5 \text{ V}$, $-40^\circ C < T_J < 125^\circ C$			0.4	V
	Enable input logic high		0.9			V
I_{EN}	Enable pin input current	$V_{EN} = V_{IN}$		0.1	100	nA
T_{ON}	Turn-on time ⁽⁴⁾			30		μs
T_{SHDN}	Thermal shutdown			160		$^\circ C$
	Hysteresis			20		
C_{OUT}	Output capacitor	Capacitance (see typical performance characteristics for stability)	1		22	μF

1. All transient values are guaranteed by design, not tested in production.
2. Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value. This specification does not apply to output voltages below 1.5 V.
3. PG pin floating.
4. Turn-on time is time measured between the enable input just exceeding V_{EN} high value and the output voltage just reaching 95% of its nominal value.

5 Typical performance characteristics

$$C_{IN} = C_{OUT} = 1 \mu F$$

Figure 4. V_{ADJ} accuracy

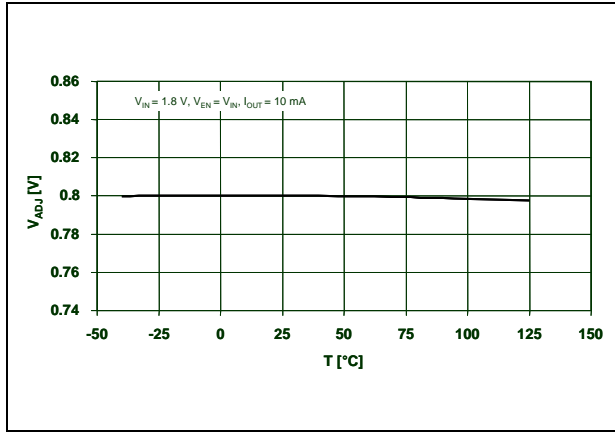


Figure 5. V_{OUT} accuracy

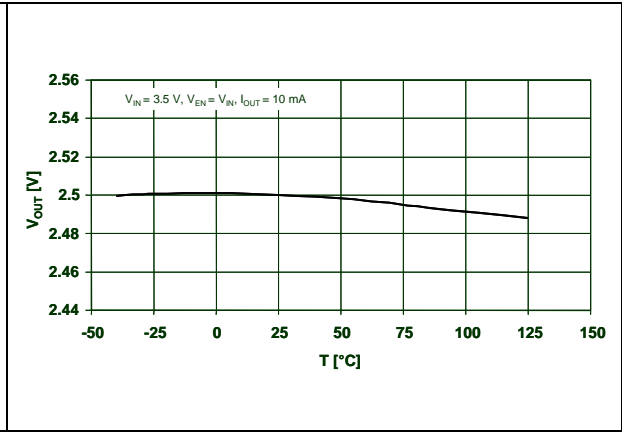


Figure 6. Dropout voltage vs. temperature ($V_{OUT} = 2.5 V$)

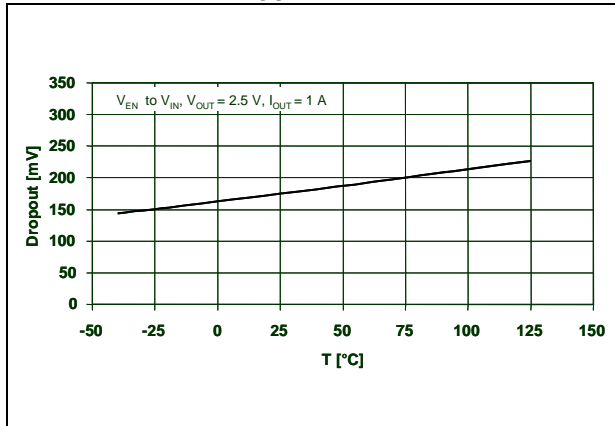


Figure 7. Dropout voltage vs. temperature ($V_{OUT} = 1.5 V$)

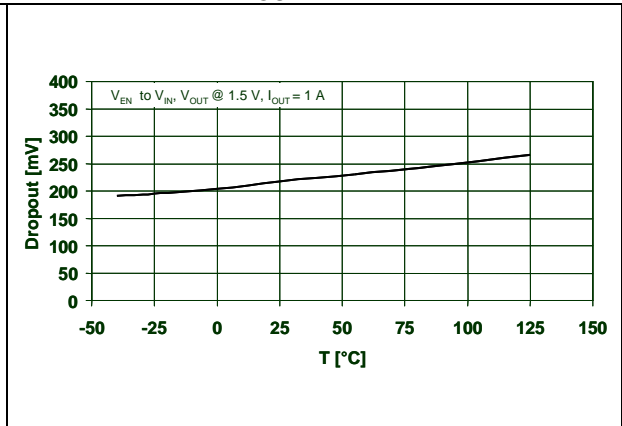


Figure 8. Dropout voltage vs. output current

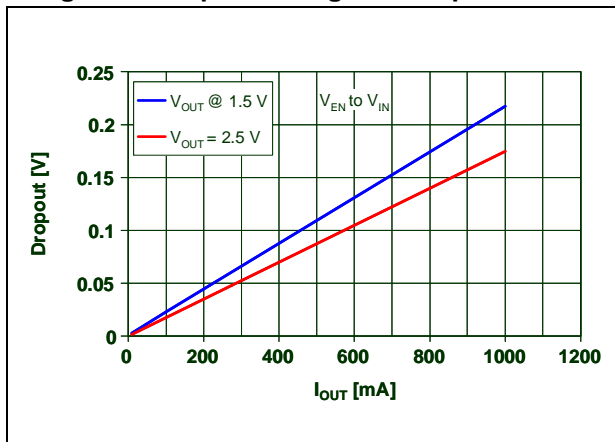


Figure 9. Short-circuit current vs. drop voltage

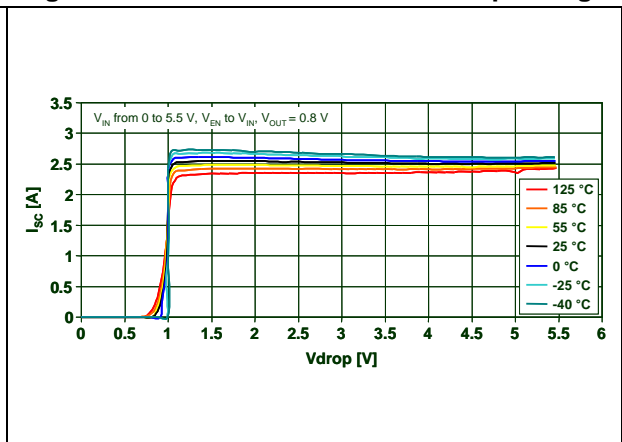


Figure 10. Output voltage vs. input voltage ($V_{OUT} = 0.8\text{ V}$)

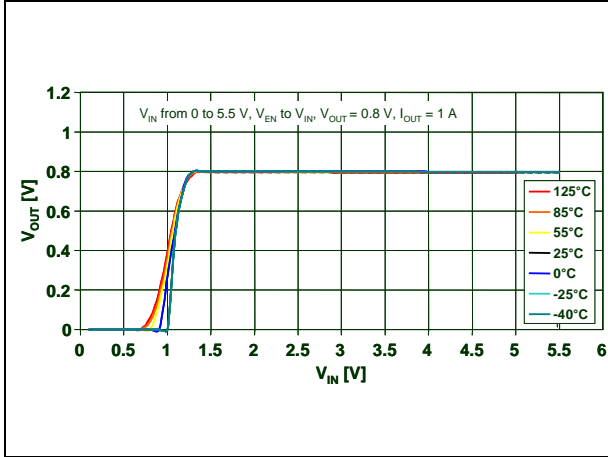


Figure 11. Output voltage vs. input voltage ($V_{OUT} = 2.5\text{ V}$)

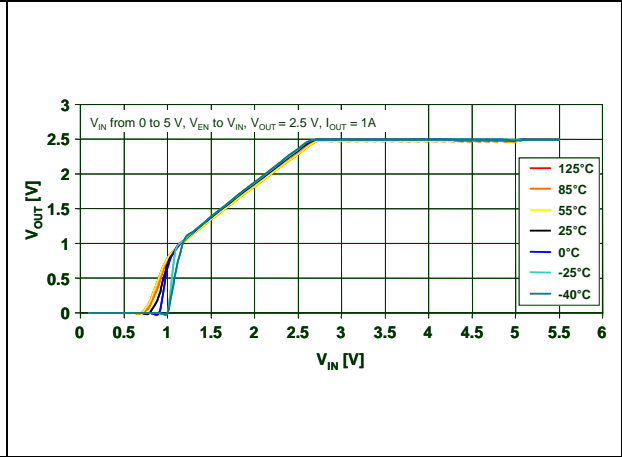


Figure 12. Quiescent current vs. temperature

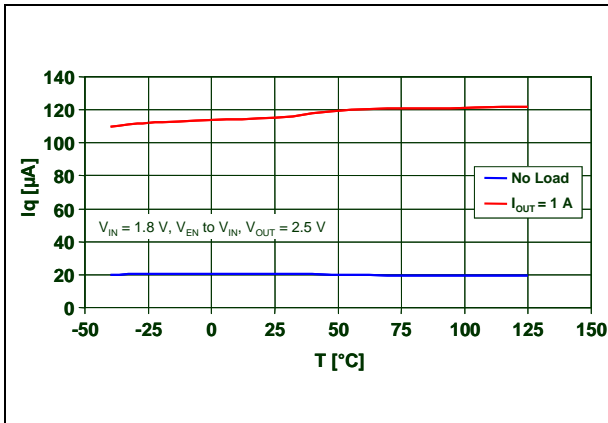


Figure 13. V_{IN} input current in off mode vs. temperature

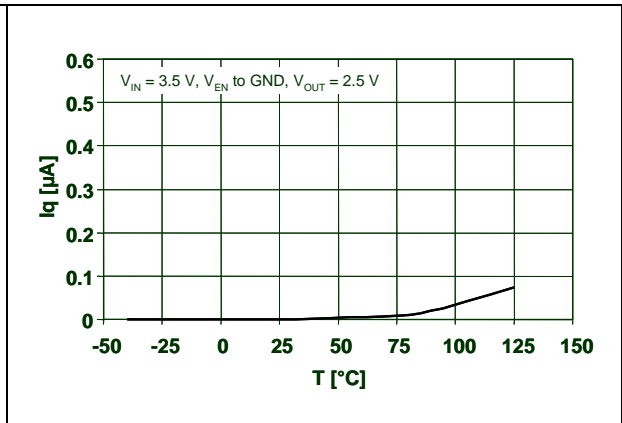


Figure 14. Load regulation

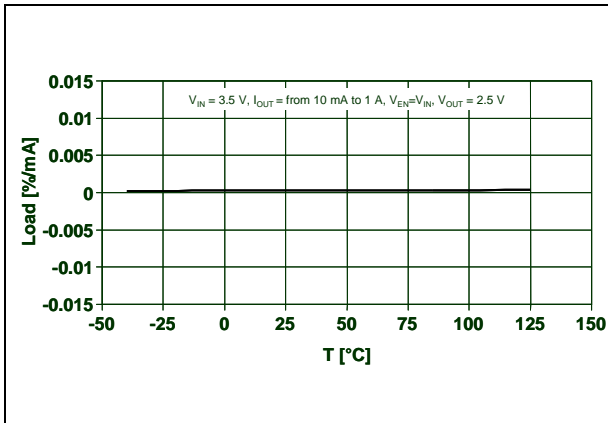


Figure 15. Line regulation $V_{OUT}=0.8\text{ V}$

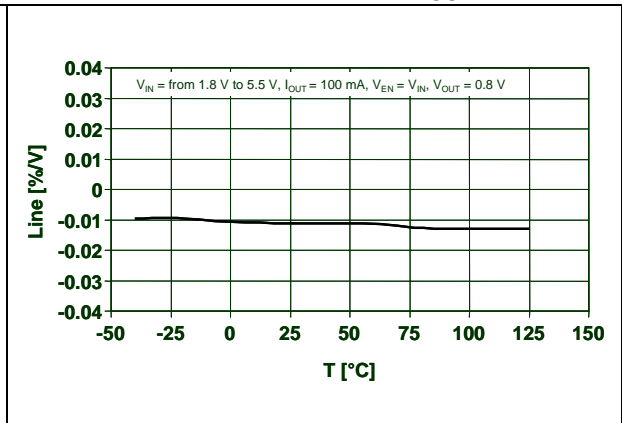


Figure 16. Line regulation $V_{OUT}=2.5\text{ V}$

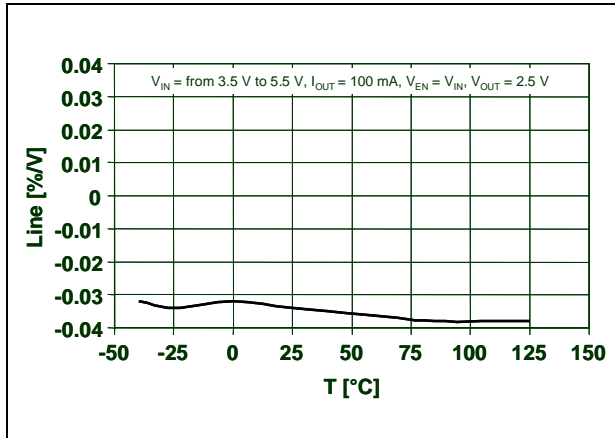


Figure 17. Supply voltage rejection vs. temperature ($V_{OUT} = 0.8\text{ V}$)

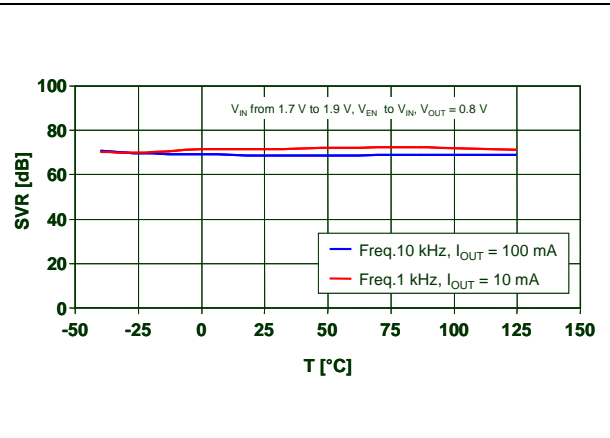


Figure 18. Supply voltage rejection vs. temperature ($V_{OUT} = 2.5\text{ V}$)

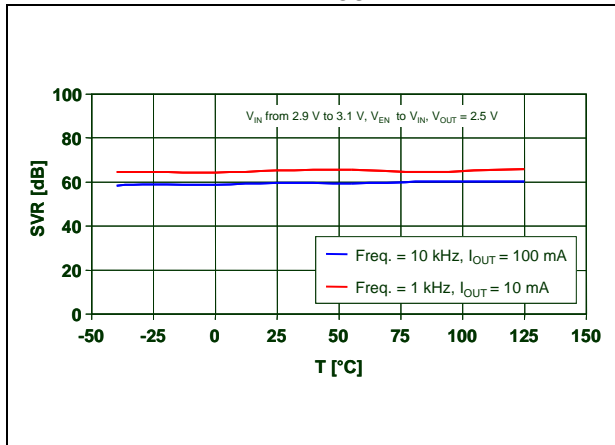


Figure 19. Supply voltage rejection vs. frequency ($V_{OUT} = 0.8\text{ V}$)

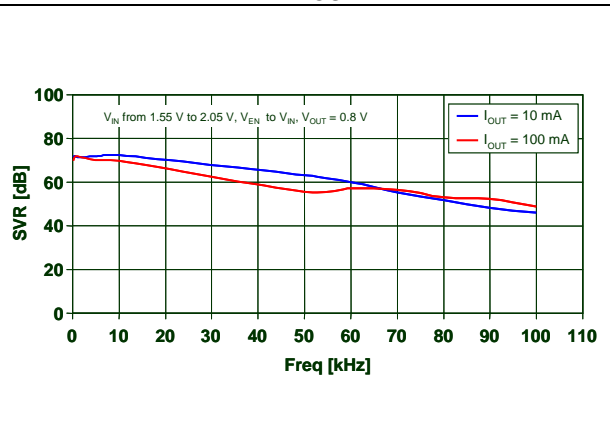


Figure 20. Supply voltage rejection vs. frequency ($V_{OUT} = 2.5\text{ V}$)

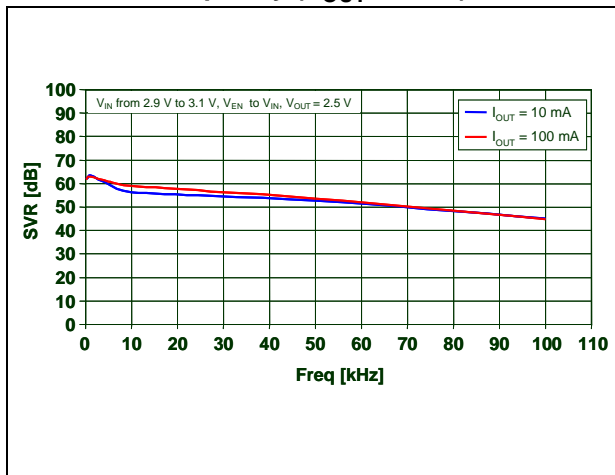


Figure 21. Output noise voltage vs. frequency

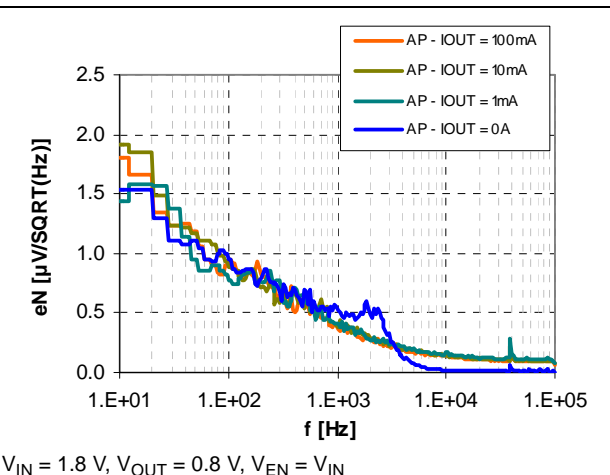


Figure 22. Enable voltage vs. temperature

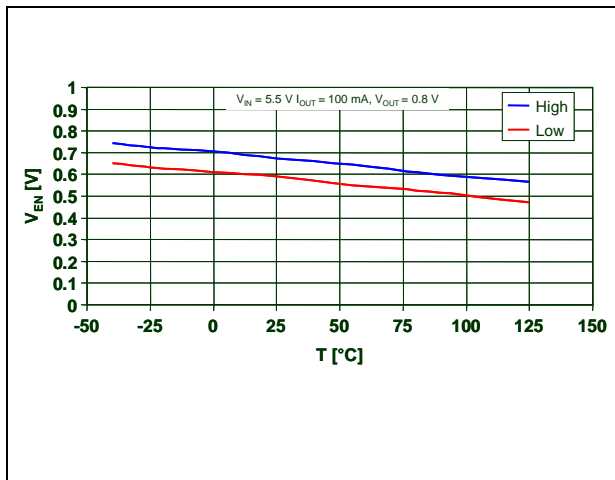


Figure 23. Load transient (I_{OUT} = from 10 mA to 1 A)

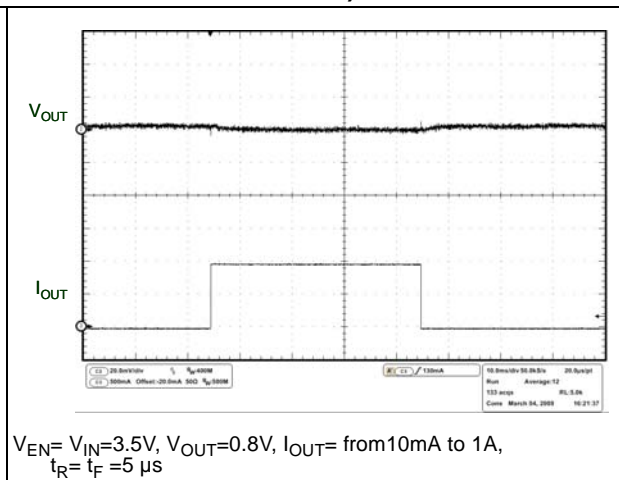


Figure 24. Load transient ($V_{OUT} = 0.8\text{ V}$)

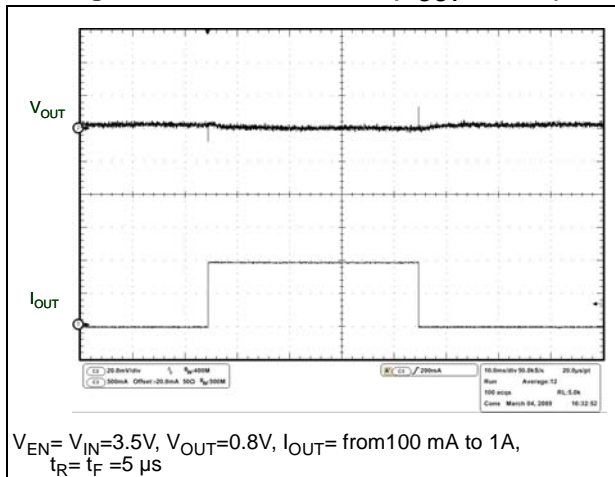


Figure 25. Load transient ($V_{OUT} = 2.5\text{ V}$)

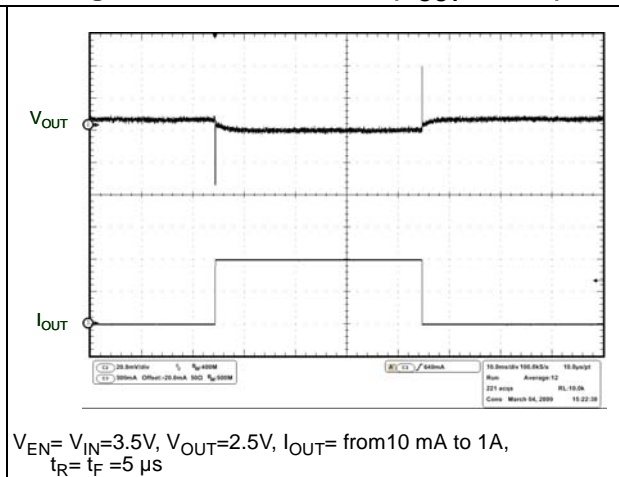


Figure 26. Load transient (I_{OUT} = from 100 mA to 1 A)

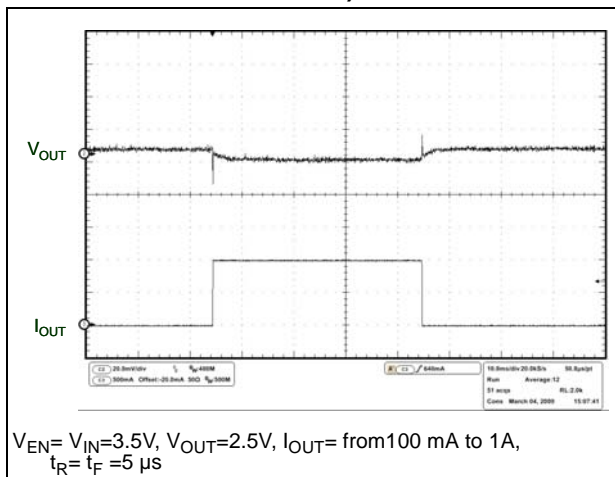


Figure 27. Line regulation transient

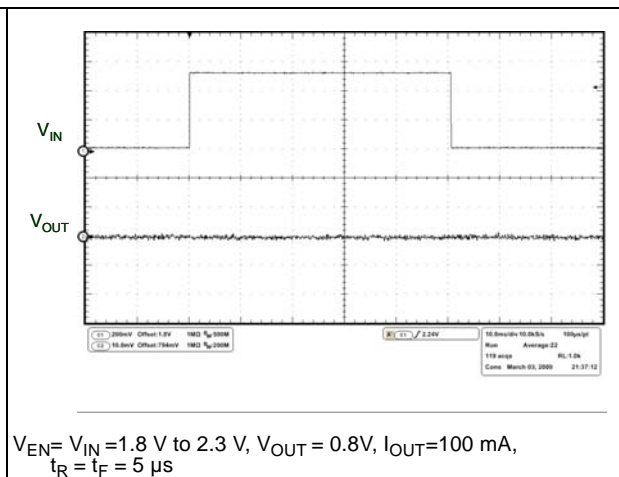


Figure 28. Start-up transient

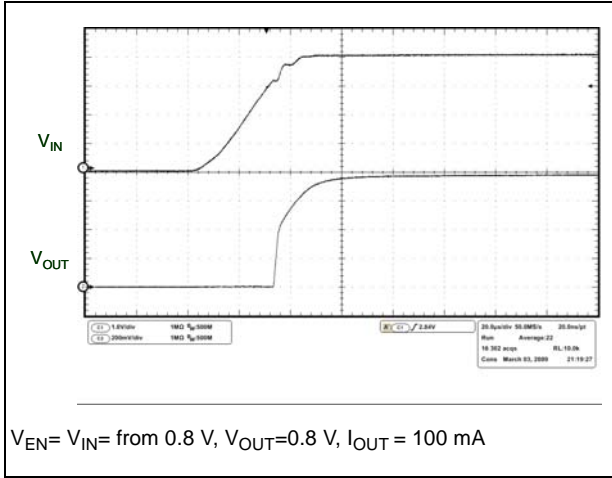


Figure 29. Enable transient

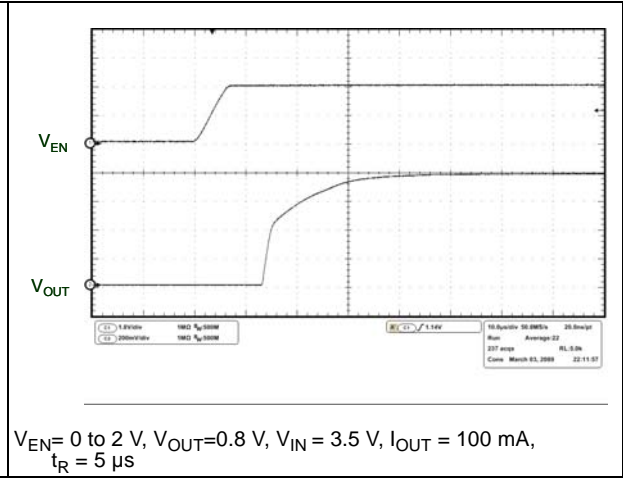


Figure 30. ESR required for stability with ceramic capacitors ($V_{OUT} = 0.8$ V)

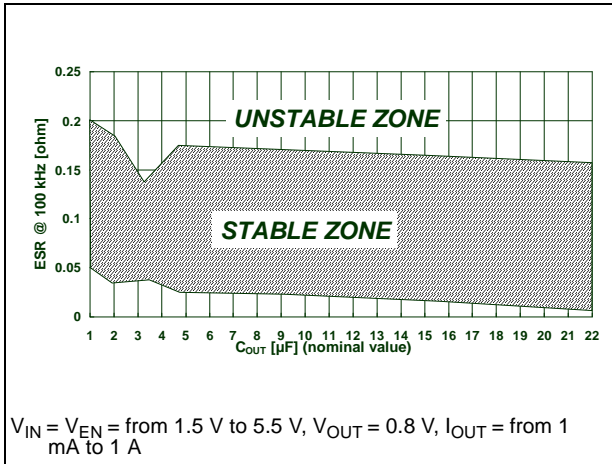
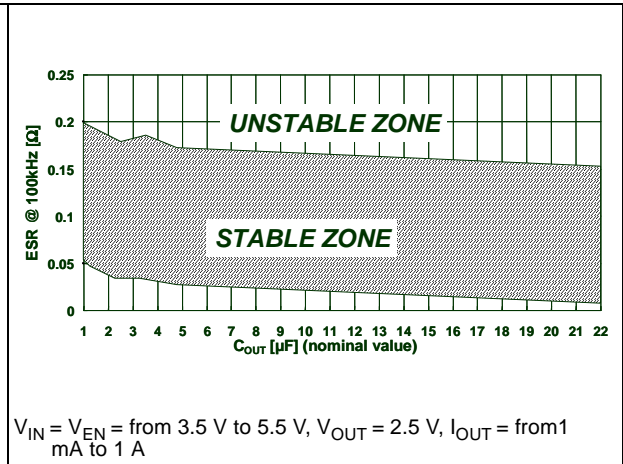


Figure 31. ESR required for stability with ceramic capacitors ($V_{OUT} = 2.5$ V)



6 Application information

The LD39100 is an ultra low-dropout linear regulator. It provides up to 1 A with a low 200 mV dropout. The input voltage range is from 1.5 V to 5.5 V. The device is available in fixed and adjustable output versions.

The regulator is equipped with internal protection circuitry, such as short-circuit current limiting and thermal protection.

The regulator is stable with ceramic capacitors on the input and the output. The expected values of the input and output ceramic capacitors are from 1 μ F to 22 μ F with 1 μ F typical. The input capacitor has to be connected within 1 cm from V_{IN} terminal. The output capacitor has also to be connected within 1 cm from output pin. There isn't any upper limit to the value of the input capacitor.

Figure 32 and *Figure 33* illustrate the typical application schematics:

Figure 32. Typical application circuit for fixed output version

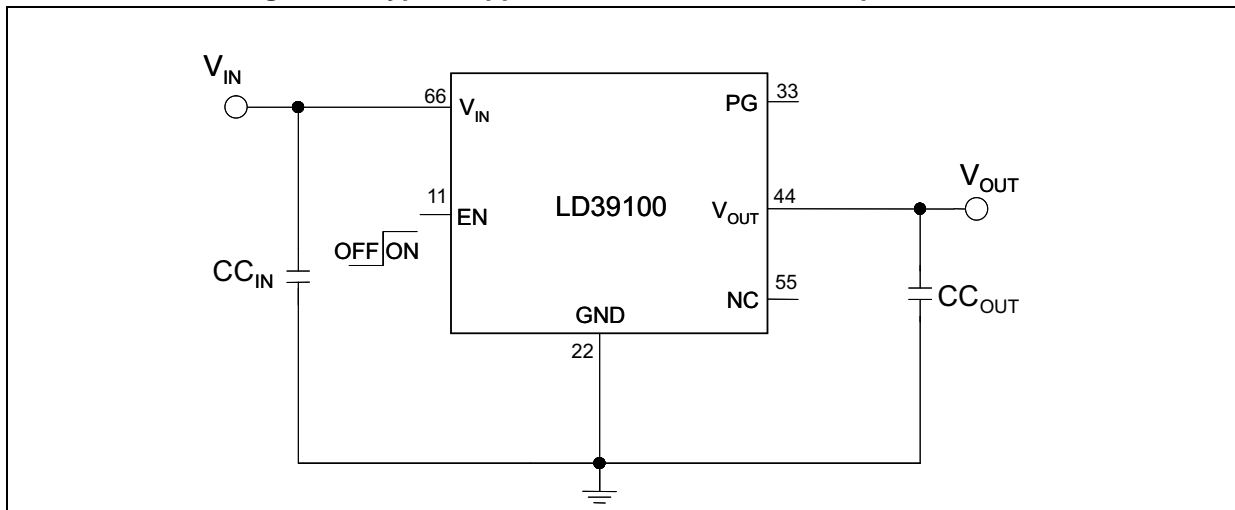
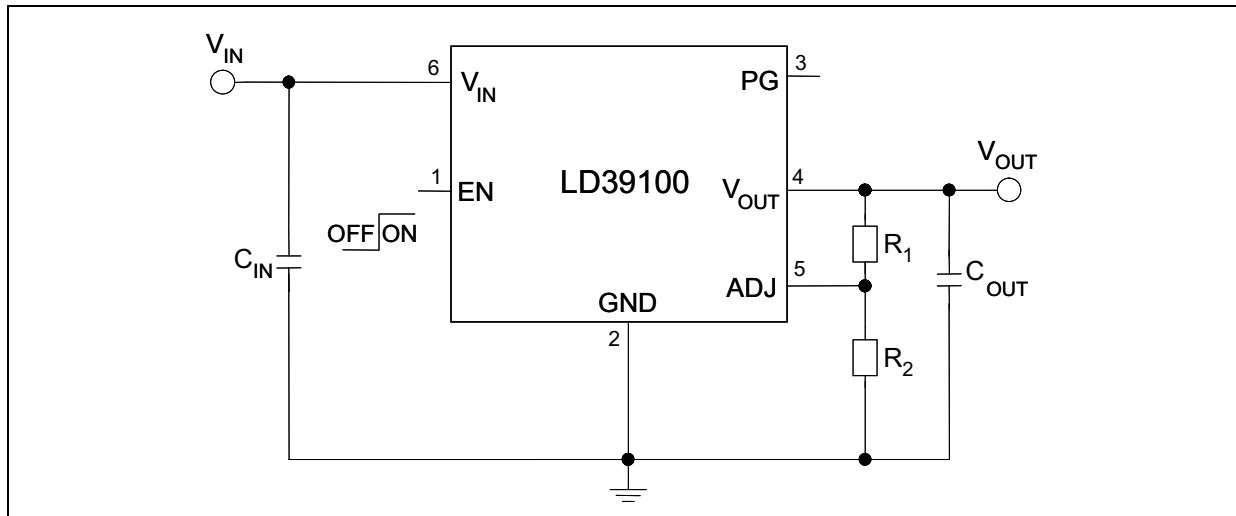


Figure 33. Typical application circuit for adjustable version



Regarding to the adjustable version, the output voltage can be adjusted from 0.8 V up to the input voltage, minus PMOS voltage drop across (dropout voltage), by connecting a resistor divider between ADJ pin and the output, thus allowing remote voltage sensing.

The resistor divider should be selected as follows:

Equation 1

$$V_{OUT} = V_{ADJ} (1 + R_1 / R_2) \text{ with } V_{ADJ} = 0.8 \text{ V (typ.)}$$

Resistors should be used with values in the range from 10 k Ω to 50 k Ω . Lower values can also be suitable, but they increase current consumption.

6.1 Power dissipation

An internal thermal feedback loop disables the output voltage if the die temperature rises to approximately 160 °C. This feature protects the device from excessive temperature and allows the user to push the limits of the power handling capability of a given circuit board without the risk of damaging the device.

A good PC board layout should be used to maximize power dissipation. The thermal path for the heat generated by the device is from the die to the copper lead frame through the package leads and exposed pad to the PC board copper. The PC board copper acts as a heatsink. The footprint copper pads should be as wide as possible to spread and dissipate the heat to the surrounding ambient. Feed-through vias to the inner or backside copper layers are also useful to improve the overall thermal performance of the device.

The device power dissipation depends on the input voltage, output voltage and output current, and is given by:

Equation 2

$$P_D = (V_{IN} - V_{OUT}) I_{OUT}$$

Junction temperature of the device is:

Equation 3

$$T_{J_MAX} = T_A + R_{thJA} \times P_D$$

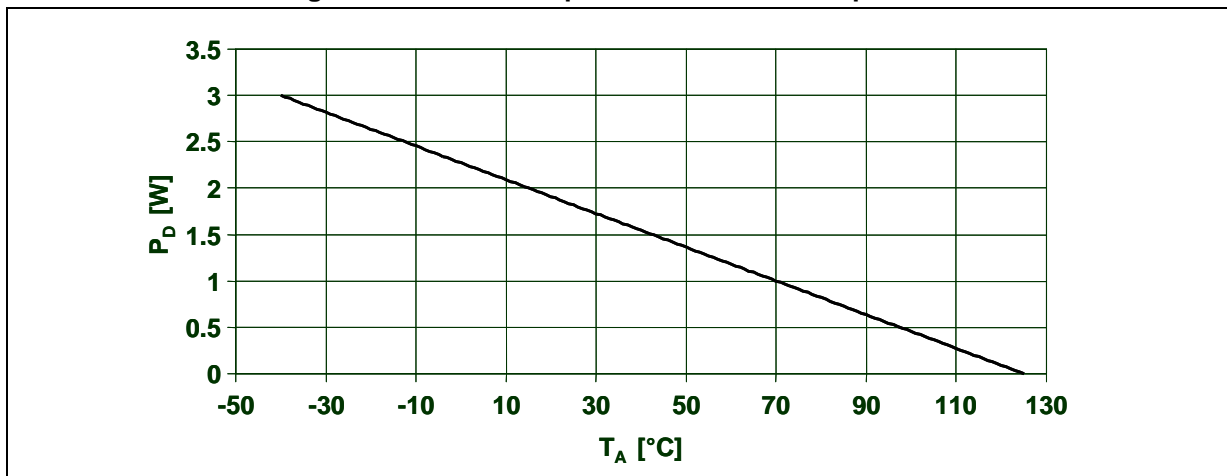
where:

T_{J_MAX} is the maximum junction of the die, 125 °C

T_A is the ambient temperature

R_{thJA} is the thermal resistance junction-to-ambient

Figure 34. Power dissipation vs. ambient temperature



6.2 Enable function

The LD39100 features the enable function. When EN voltage is higher than 2 V, the device is ON, and if it is lower than 0.8 V, the device is OFF. In shutdown mode, consumption is lower than 1 μ A.

EN pin has not an internal pull-up, so it cannot be left floating if it is not used.

6.3 Power Good function

Most applications require a flag showing that the output voltage is in the correct range.

Power Good threshold depends on the adjust voltage. When it is higher than $0.92 \times V_{ADJ}$, Power Good (PG) pin goes to high impedance. If it is below $0.80 \times V_{ADJ}$ PG pin goes to low impedance. If the device works well, Power Good pin is at high impedance. If the output voltage is fixed using an external or internal resistor divider, Power Good threshold is $0.92 \times V_{OUT}$.

Power Good function requires an external pull-up resistor, which has to be connected between PG pin and V_{IN} or V_{OUT} . PG pin typical current capability is up to 6 mA. A pull-up resistor for PG should be in the range from 100 k Ω to 1 M Ω . If Power Good function is not used, PG pin has to remain floating.

7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Figure 35. DFN6 (3x3 mm) drawings

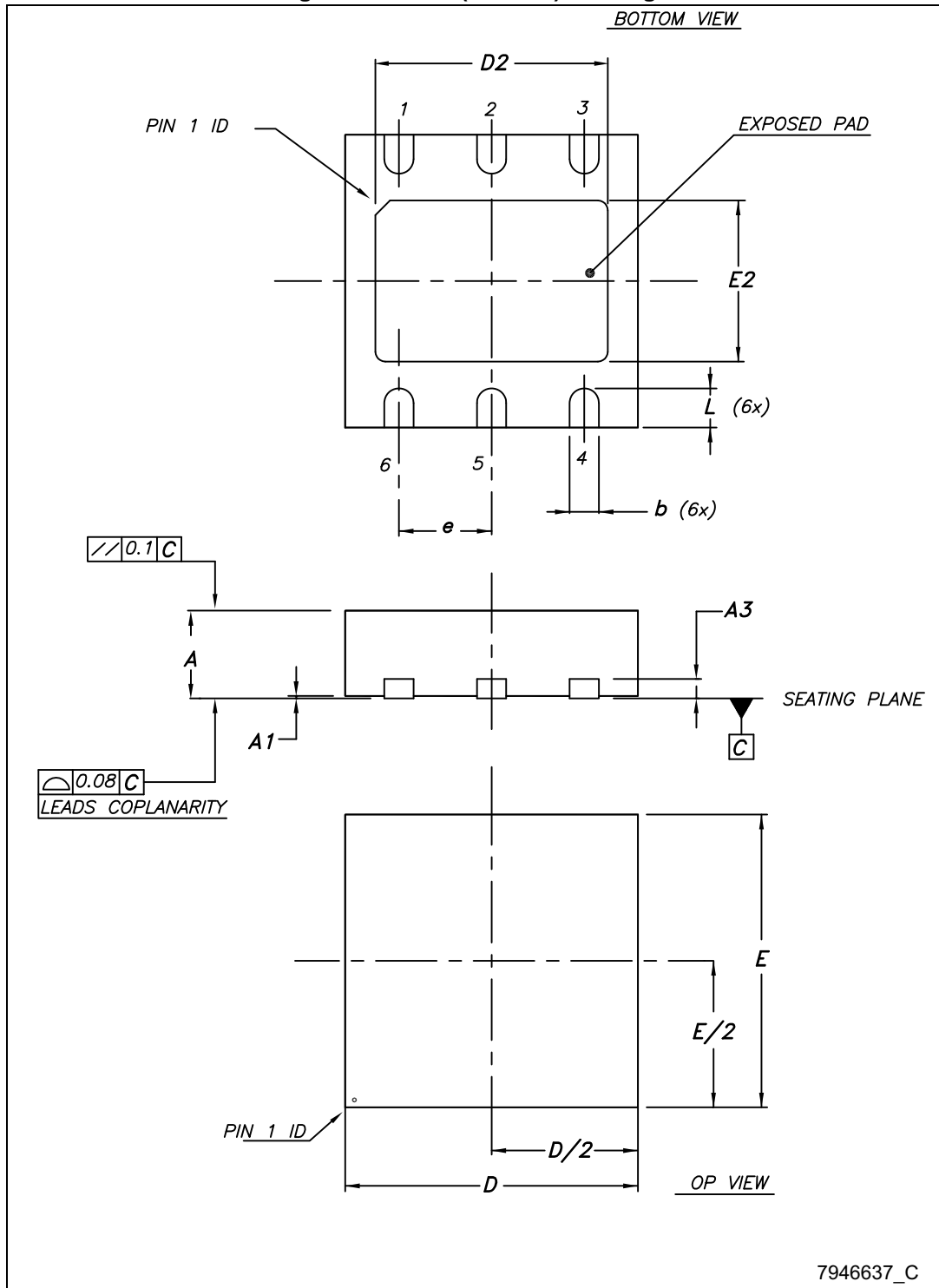
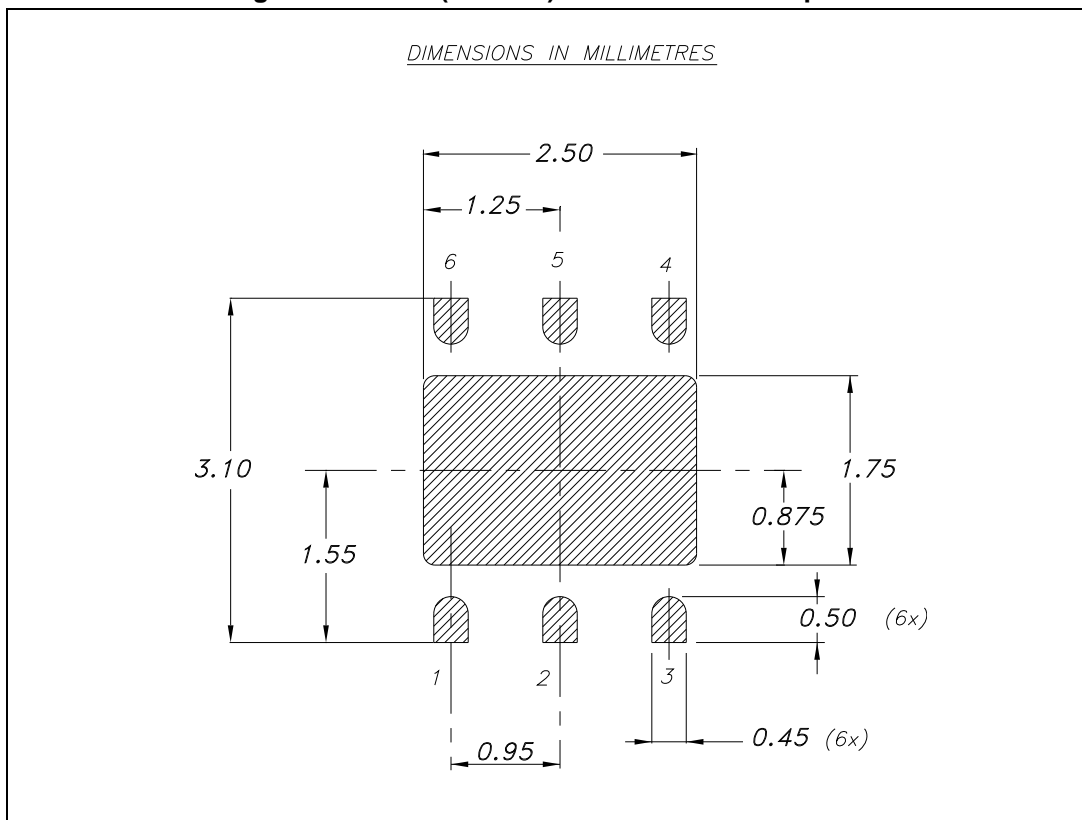


Table 8. DFN6 (3x3 mm) mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1
A1	0	0.02	0.05
A3		0.20	
b	0.23		0.45
D	2.90	3	3.10
D2	2.23		2.50
E	2.90	3	3.10
E2	1.50		1.75
e		0.95	
L	0.30	0.40	0.50

Figure 36. DFN6 (3x3 mm) recommended footprint



8 Packaging mechanical data

Figure 37. DFN6 (3x3 mm) tape

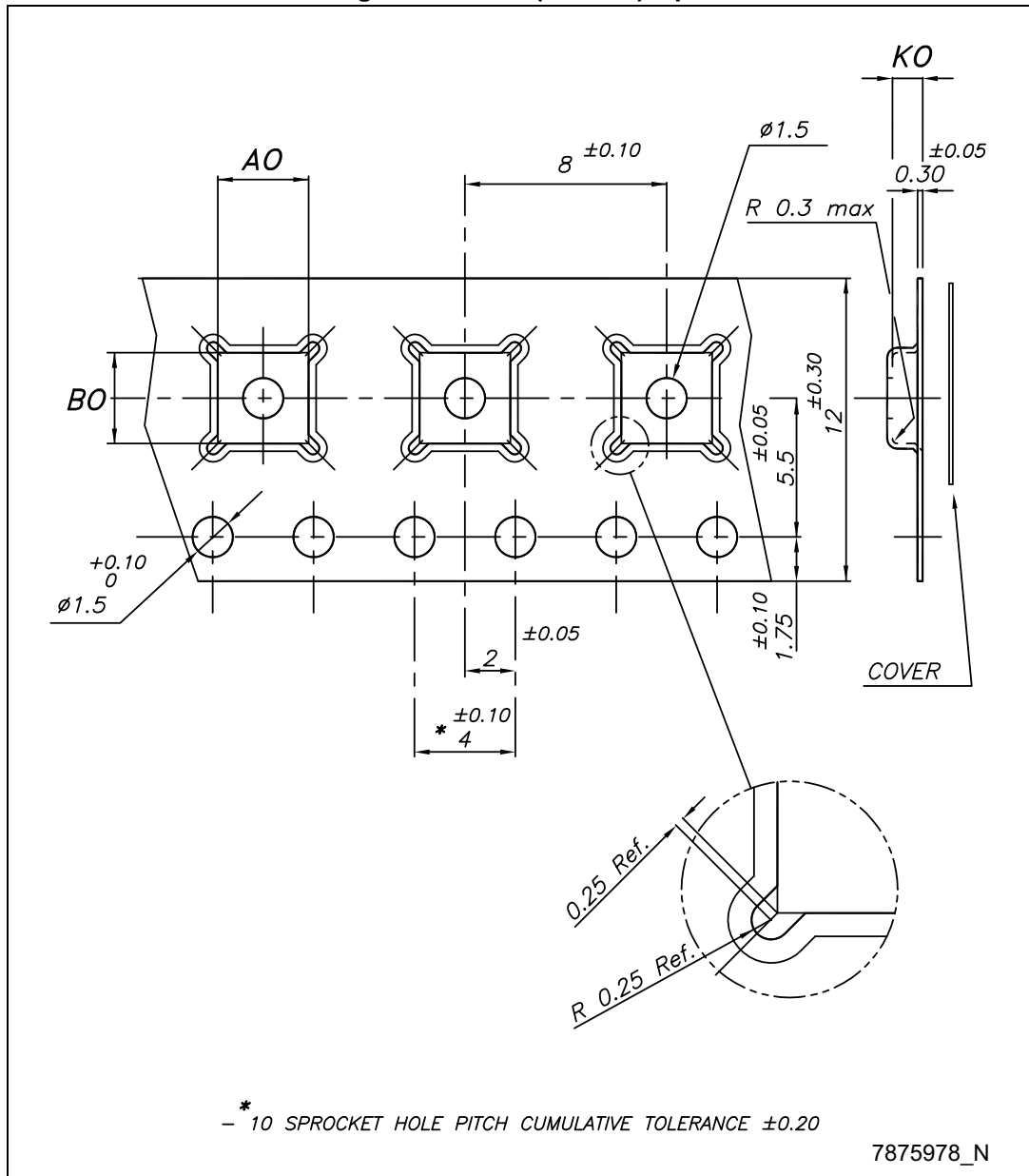


Figure 38. DFN6 (3x3 mm) reel

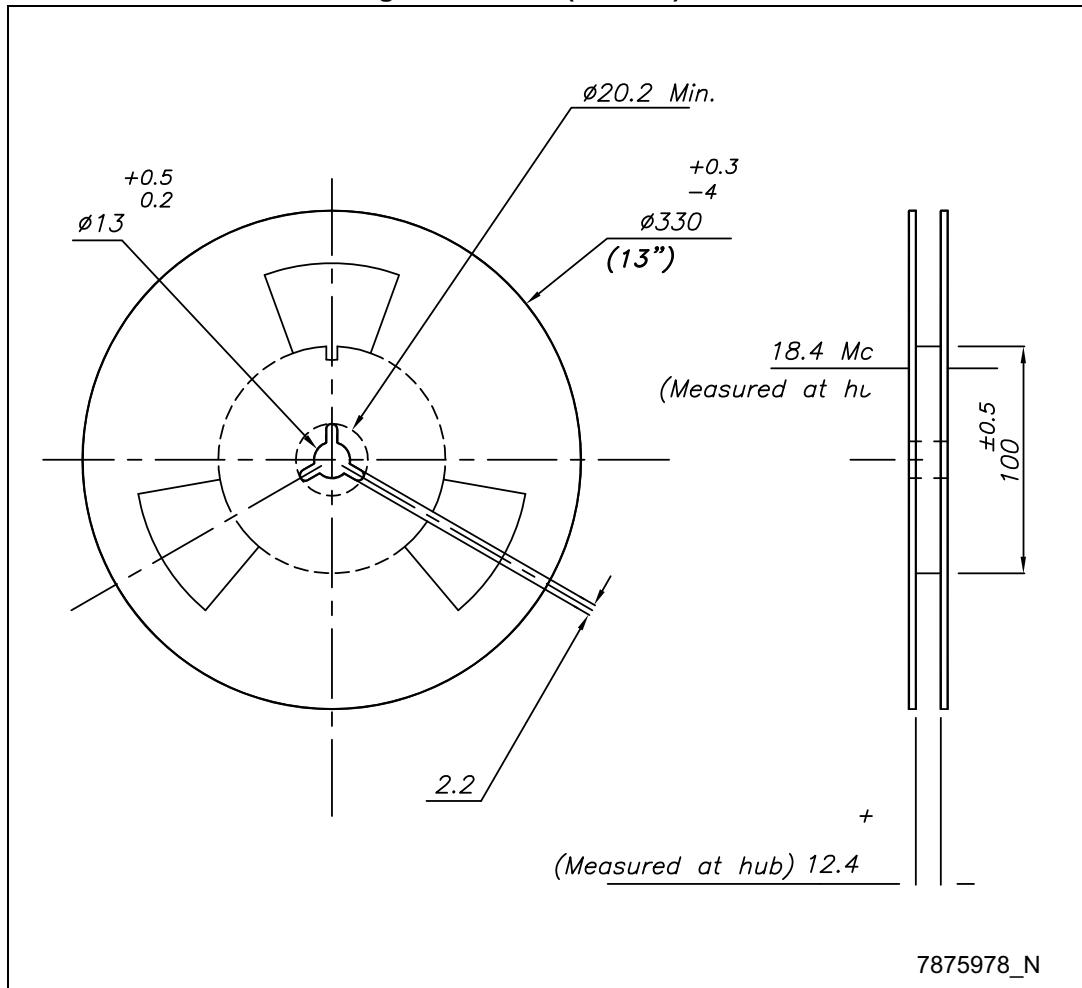


Table 9. DFN6 (3x3 mm) tape and reel mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A0	3.20	3.30	3.40
B0	3.20	3.30	3.40
K0	1	1.10	1.20

9 Revision history

Table 10. Document revision history

Date	Revision	Changes
29-Jul-2009	1	Initial release.
16-Apr-2010	2	Modified Figure 8 on page 9 .
11-Oct-2011	3	Document status promoted from preliminary data to datasheet.
24-Apr-2014	4	Part numbers LD39100xx, LD39100xx12 and LD39100xx25 changed to LD39100. Updated Table 1: Device summary . Updated the description in cover page Section 1: Circuit schematics , Section 2: Pin configuration , Section 4: Electrical characteristics , Section 5: Typical performance characteristics , Figure 32: Typical application circuit for fixed output version , Section 7: Package mechanical data . Deleted previous Section 8: Different output voltage versions of the LD39100xx available on request . Added Section 8: Packaging mechanical data . Minor text changes.

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2014 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

